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Global Resin-Bonded Grinding Wheels for SiC Wafers Market Growth 2026-2032

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Abstracts

The global Resin-Bonded Grinding Wheels for SiC Wafers market size is predicted to grow from US$ 115 million in 2025 to US$ 305 million in 2032; it is expected to grow at a CAGR of 15.2% from 2026 to 2032.

Resin-Bonded Grinding Wheels for SiC Wafers are specialized polishing tools for precision grinding of silicon carbide wafers. Using diamond micro-powder as abrasive material and resin bonds to form flexible grinding layers, these wheels can maintain high material removal rates while achieving excellent surface quality. They are primarily used in the final surface processing of silicon carbide substrates in the semiconductor field. The global market for resin-bonded grinding wheels for SiC wafers is approximately $109.28 million USD in 2024, with an annual sales volume of about 158,150 units. The projected CAGR for the next five years is about 14.7%. The market price is $691 per unit, single-line annual production capacity ranges from 10,000 to 15,000 units, and industry gross margins are generally between 42% and 55%.

United States market for Resin-Bonded Grinding Wheels for SiC Wafers is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

China market for Resin-Bonded Grinding Wheels for SiC Wafers is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

Europe market for Resin-Bonded Grinding Wheels for SiC Wafers is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

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Global key Resin-Bonded Grinding Wheels for SiC Wafers players cover Disco, Asahi Diamond Industrial, Meister Abrasives, Moresuperhard, Tokyo Diamond Tools, etc. In terms of revenue, the global two largest companies occupied for a share nearly % in 2025.

Report Scope

LP Information, Inc. (LPI) ' newest research report, the “Resin-Bonded Grinding Wheels for SiC Wafers Industry Forecast” looks at past sales and reviews total world Resin-Bonded Grinding Wheels for SiC Wafers sales in 2025, providing a comprehensive analysis by region and market sector of projected Resin-Bonded Grinding Wheels for SiC Wafers sales for 2026 through 2032. With Resin-Bonded Grinding Wheels for SiC Wafers sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US$ millions of the world Resin-Bonded Grinding Wheels for SiC Wafers industry.

This Insight Report provides a comprehensive analysis of the global Resin-Bonded Grinding Wheels for SiC Wafers landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading global companies with a focus on Resin-Bonded Grinding Wheels for SiC Wafers portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms’ unique position in an accelerating global Resin-Bonded Grinding Wheels for SiC Wafers market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Resin-Bonded Grinding Wheels for SiC Wafers and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Resin-Bonded Grinding Wheels for SiC Wafers.

This report presents a comprehensive overview, market shares, and growth opportunities of Resin-Bonded Grinding Wheels for SiC Wafers market by product type, application, key manufacturers and key regions and countries.

Market Segmentation

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Segmentation by Type:

Surface Grinding Wheels

Cup Wheels

Customized Wheels

Segmentation by Grinding Accuracy:

Standard Grade

Ultra-Precision Grade

Segmentation by Application:

Precision Optics

Semiconductor

Others

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

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China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered

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from primary experts and analysing the company's coverage, product portfolio, its market penetration.

Disco

Asahi Diamond Industrial

Meister Abrasives

Moresuperhard

Tokyo Diamond Tools

A.L.M.T. Corp (Sumitomo Electric)

Tokyo Seimitsu

Saint-Gobain

EHWA DIAMOND

Zhengzhou Qisheng Precision Manufacturing

Carbo Tzujan Industry

KINIK COMPANY

China National Machinery Industry Corporation

Key Questions Addressed in this Report

What is the 10-year outlook for the global Resin-Bonded Grinding Wheels for SiC Wafers market?

What factors are driving Resin-Bonded Grinding Wheels for SiC Wafers market growth, globally and by region?

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Which technologies are poised for the fastest growth by market and region?

How do Resin-Bonded Grinding Wheels for SiC Wafers market opportunities vary by end market size?

How does Resin-Bonded Grinding Wheels for SiC Wafers break out by Type, by Application?

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